



REVISION HISTORY

<u>Revision</u>	<u>Description</u>	<u>Issue Date</u>
Rev. 1.0	Initial Issue	Jul.25.2004
Rev. 1.1	Delete I _{CC1} Spec.	Sep.21.2004
Rev. 2.0	Adding -10ns Spec.	Aug.30.2005
Rev. 2.1	Revised V _{TERM} to V _{T1} and V _{T2} Revised TEST CONDITION of I _{SB1} /I _{DR} Added LL Spec.	Feb.02.2009
Rev.2.2	Revised TEST CONDITION of I _{CC} /I _{SB} Revised FEATURES & ORDERING INFORMATION Lead free and green package available to Green package available Deleted T _{SOLDER} in ABSOLUTE MAXIMUN RATINGS Added packing type in ORDERING INFORMATION	Apr.17.2009
Rev. 2.3	Revised PACKAGE OUTLINE DIMENSION in page 9	Dec.18.2009
Rev. 2.4	Added I grade in normal grade Deleted -10/12/15ns Spec. in LL grade Added -18ns Spec. In LL grade	Apr.27.2010
Rev. 2.5	Revised PACKAGE OUTLINE DIMENSION in page 10/11	May.07.2010
Rev. 2.6	Revised ORDERING INFORMATION in page 12	Aug.30.2010
Rev. 2.7	Add package type: TFBGA 36-ball Revised ORDERING INFORMATION in page 14~page15	Jan.23.2013
Rev. 2.8	Deleted -15ns Spec. Deleted WRITE CYCLE Notes : 1. WE#, CE# must be high or CE2 must be low during all address transitions in page 7.	Dec.13.2016

FEATURES

- Fast access time : 10/12/18ns
- Low power consumption:
 Operating current : 75/70/55mA (TYP.)
 Standby current : 0.6mA (TYP.)
 1 μ A (TYP.) LL -version
- Single 3.3V power supply
- All inputs and outputs TTL compatible
- Fully static operation
- Tri-state output
- Data retention voltage : 2.0V (MIN.)
- **Green package available**
- Package : 32-pin 300 mil SOJ
 32-pin 8mm x 20mm TSOP I
 32-pin 8mm x 13.4mm sTSOP
 36-ball 6mm x 8mm TFBGA

GENERAL DESCRIPTION

The LY61L1024 is a 1,048,576-bit low power CMOS static random access memory organized as 131,072 words by 8 bits. It is fabricated using very high performance, high reliability CMOS technology. Its standby current is stable within the range of operating temperature.

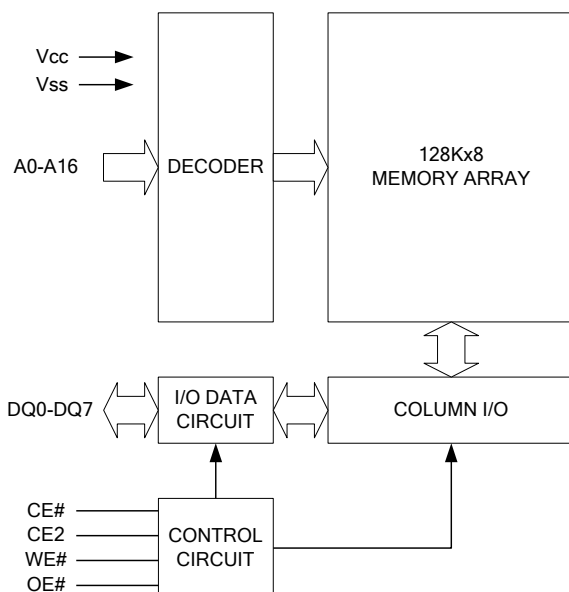
The LY61L1024 is well designed for very high speed system applications, and particularly well suited for battery back-up nonvolatile memory application.

The LY61L1024 operates from a single power supply of 3.3V and all inputs and outputs are fully TTL compatible

PRODUCT FAMILY

Product Family	Operating Temperature	V _{CC} Range	Speed	Power Dissipation	
				Standby(I _{SB1} , TYP.)	Operating(I _{CC} , TYP.)
LY61L1024	0 ~ 70°C	3.15 ~ 3.6V	10ns	0.6mA	75mA
LY61L1024	0 ~ 70°C	3.0 ~ 3.6V	12ns	0.6mA	70mA
LY61L1024(I)	-40 ~ 85°C	3.15 ~ 3.6V	10ns	0.6mA	75mA
LY61L1024(I)	-40 ~ 85°C	3.0 ~ 3.6V	12ns	0.6mA	70mA
LY61L1024(LL)	0 ~ 70°C	3.0 ~ 3.6V	18ns	1 μ A	55mA
LY61L1024(LLI)	-40 ~ 85°C	3.0 ~ 3.6V	18ns	1 μ A	55mA

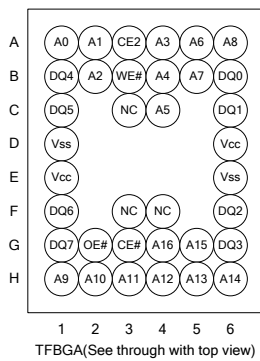
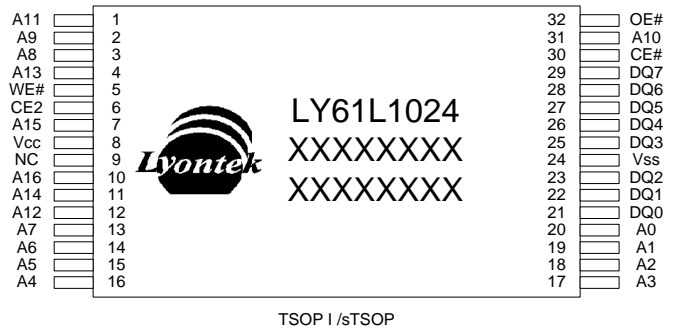
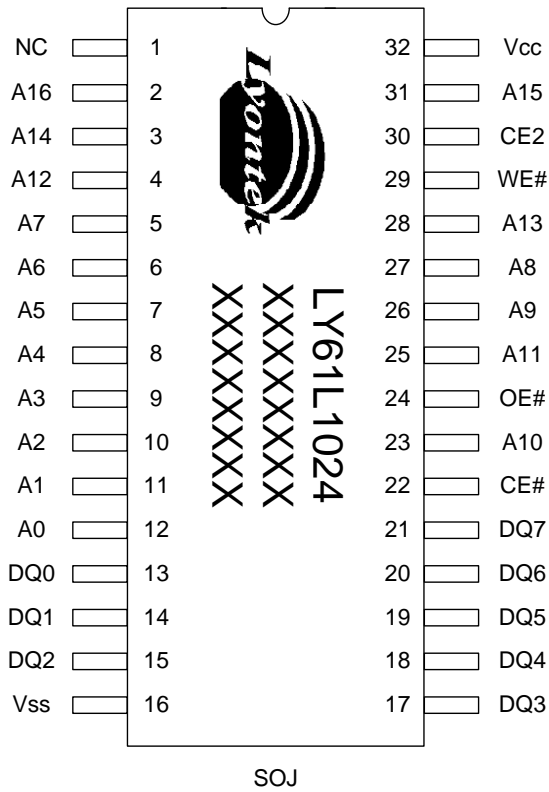
FUNCTIONAL BLOCK DIAGRAM



PIN DESCRIPTION

SYMBOL	DESCRIPTION
A0 - A16	Address Inputs
DQ0 - DQ7	Data Inputs/Outputs
CE#, CE2	Chip Enable Inputs
WE#	Write Enable Input
OE#	Output Enable Input
V _{CC}	Power Supply
V _{SS}	Ground
NC	No Connection

PIN CONFIGURATION



PS: All pin out definition are relative with "Lyontek logo" orientation.

ABSOLUTE MAXIMUM RATINGS*

PARAMETER	SYMBOL	RATING	UNIT
Voltage on V _{CC} relative to V _{SS}	V _{T1}	-0.5 to 4.6	V
Voltage on any other pin relative to V _{SS}	V _{T2}	-0.5 to V _{CC} +0.5	V
Operating Temperature	T _A	0 to 70(C grade)	°C
		-40 to 85(I grade)	
Storage Temperature	T _{STG}	-65 to 150	°C
Power Dissipation	P _D	1	W
DC Output Current	I _{OUT}	50	mA

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to the absolute maximum rating conditions for extended period may affect device reliability.

TRUTH TABLE

MODE	CE#	CE2	OE#	WE#	I/O OPERATION	SUPPLY CURRENT
Standby	H	X	X	X	High-Z	I _{SB} , I _{SB1}
	X	L	X	X	High-Z	I _{SB} , I _{SB1}
Output Disable	L	H	H	H	High-Z	I _{CC}
Read	L	H	L	H	D _{OUT}	I _{CC}
Write	L	H	X	L	D _{IN}	I _{CC}

Note: H = V_{IH}, L = V_{IL}, X = Don't care.



DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP. ⁴	MAX.	UNIT	
Supply Voltage	V _{CC}		3.0	3.3	3.6	V	
Input High Voltage	V _{IH} ^{*1}		2.0	-	V _{CC} +0.5	V	
Input Low Voltage	V _{IL} ^{*2}		- 0.5	-	0.6	V	
Input Leakage Current	I _{LI}	V _{CC} ≥ V _{IN} ≥ V _{SS}	- 1	-	1	μA	
Output Leakage Current	I _{LO}	V _{CC} ≥ V _{OUT} ≥ V _{SS} , Output Disabled	- 1	-	1	μA	
Output High Voltage	V _{OH}	I _{OH} = -4mA	2.2	-	-	V	
Output Low Voltage	V _{OL}	I _{OL} = 8mA	-	-	0.4	V	
Average Operating Power supply Current	I _{CC}	Cycle time = MIN. CE# = V _{IL} and CE2 = V _{IH} , I _{I/O} = 0mA Others at V _{IL} or V _{IH}	-10	-	75	120	mA
			-12	-	70	100	mA
			-18	-	55	80	mA
Standby Power Supply Current	I _{SB}	CE# = V _{IH} or CE2 = V _{IL} Others at V _{IL} or V _{IH}	-	3	20	mA	
	I _{SB1}	CE# ≥ V _{CC} -0.2V or CE2 ≤ 0.2V	Normal	-	0.6	3	mA
		CE# ≥ V _{CC} -0.2V or CE2 ≤ 0.2V Others at 0.2V or V _{CC} -0.2V	LL	-	1	30	μA

Notes:

- V_{IH}(max) = V_{CC} + 3.0V for pulse width less than 10ns.
- V_{IL}(min) = V_{SS} - 3.0V for pulse width less than 10ns.
- Over/Undershoot specifications are characterized, not 100% tested.
- Typical values are included for reference only and are not guaranteed or tested.
Typical valued are measured at V_{CC} = V_{CC}(TYP.) and T_A = 25°C

CAPACITANCE (T_A = 25°C, f = 1.0MHz)

PARAMETER	SYMBOL	MIN.	MAX.	UNIT
Input Capacitance	C _{IN}	-	6	pF
Input/Output Capacitance	C _{I/O}	-	8	pF

Note : These parameters are guaranteed by device characterization, but not production tested.

AC TEST CONDITIONS

Input Pulse Levels	0.2V to V _{CC} - 0.2V
Input Rise and Fall Times	3ns
Input and Output Timing Reference Levels	1.5V
Output Load	C _L = 30pF + 1TTL, I _{OH} /I _{OL} = -4mA/8mA

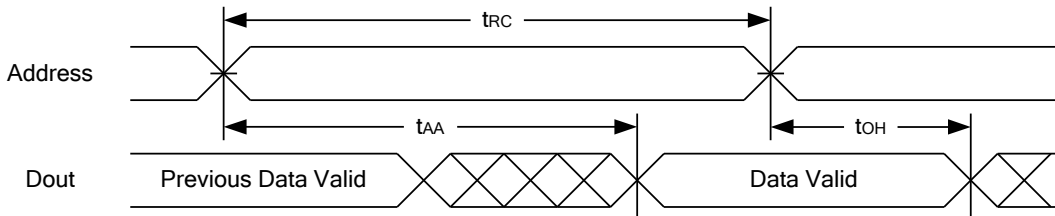
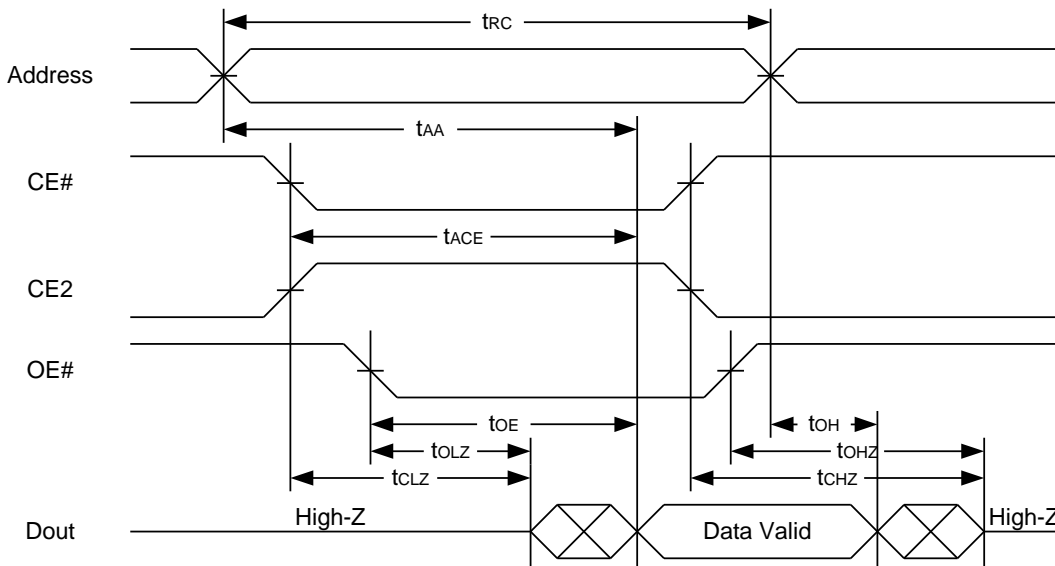
AC ELECTRICAL CHARACTERISTICS
(1) READ CYCLE

PARAMETER	SYM.	LY61L1024-10		LY61L1024-12		LY61L1024-18		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Read Cycle Time	t _{RC}	10	-	12	-	18	-	ns
Address Access Time	t _{AA}	-	10	-	12	-	18	ns
Chip Enable Access Time	t _{ACE}	-	10	-	12	-	18	ns
Output Enable Access Time	t _{OE}	-	5	-	6	-	8	ns
Chip Enable to Output in Low-Z	t _{CLZ} *	2	-	3	-	4	-	ns
Output Enable to Output in Low-Z	t _{OLZ} *	0	-	0	-	0	-	ns
Chip Disable to Output in High-Z	t _{CHZ} *	-	5	-	6	-	8	ns
Output Disable to Output in High-Z	t _{OHZ} *	-	5	-	6	-	8	ns
Output Hold from Address Change	t _{OH}	3	-	3	-	3	-	ns

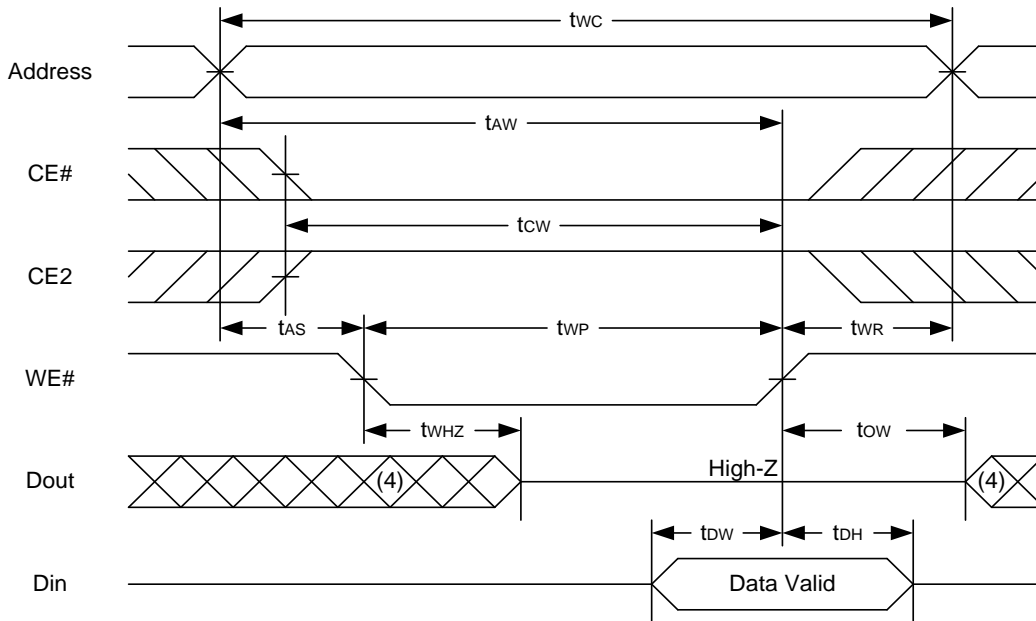
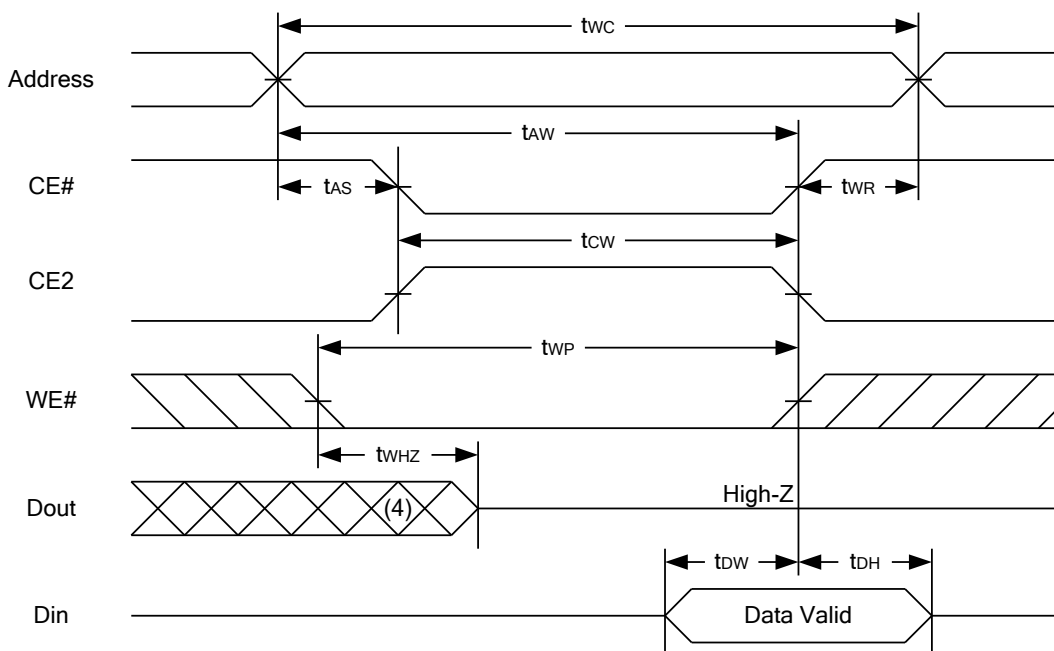
(2) WRITE CYCLE

PARAMETER	SYM.	LY61L1024-10		LY61L1024-12		LY61L1024-18		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Write Cycle Time	t _{WC}	10	-	12	-	18	-	ns
Address Valid to End of Write	t _{AW}	8	-	10	-	16	-	ns
Chip Enable to End of Write	t _{CW}	8	-	10	-	16	-	ns
Address Set-up Time	t _{AS}	0	-	0	-	0	-	ns
Write Pulse Width	t _{WP}	8	-	9	-	11	-	ns
Write Recovery Time	t _{WR}	0	-	0	-	0	-	ns
Data to Write Time Overlap	t _{DW}	6	-	7	-	9	-	ns
Data Hold from End of Write Time	t _{DH}	0	-	0	-	0	-	ns
Output Active from End of Write	t _{OW} *	2	-	3	-	5	-	ns
Write to Output in High-Z	t _{WHZ} *	-	6	-	7	-	9	ns

*These parameters are guaranteed by device characterization, but not production tested.

TIMING WAVEFORMS
READ CYCLE 1 (Address Controlled) (1,2)

READ CYCLE 2 (CE# and CE2 and OE# Controlled) (1,3,4,5)

Notes :

1. WE# is high for read cycle.
2. Device is continuously selected OE# = low, CE# = low, CE2 = high.
3. Address must be valid prior to or coincident with CE# = low, CE2 = high; otherwise tAA is the limiting parameter.
4. tCLZ, tOLZ, tCHZ and tOHZ are specified with CL = 5pF. Transition is measured ±500mV from steady state.
5. At any given temperature and voltage condition, tCHZ is less than tCLZ, tOHZ is less than tOLZ.

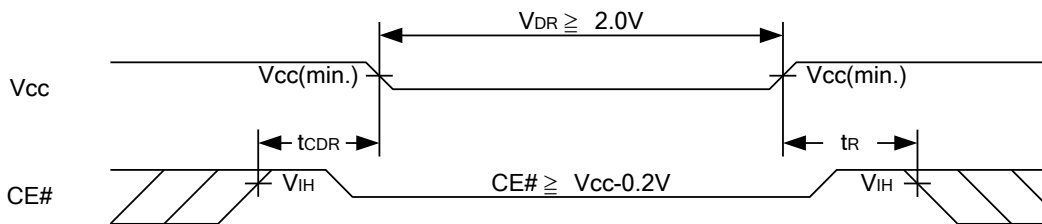
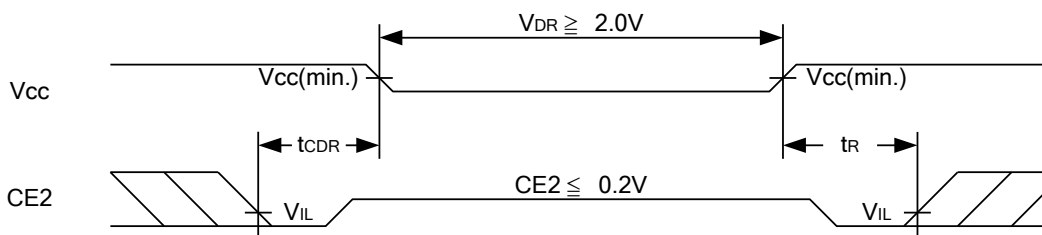
WRITE CYCLE 1 (WE# Controlled) (1,2,4,5)

WRITE CYCLE 2 (CE# and CE2 Controlled) (1,4,5)

Notes :

1. A write occurs during the overlap of a low CE#, high CE2, low WE#.
2. During a WE# controlled write cycle with OE# low, t_{WP} must be greater than $t_{WHZ} + t_{DW}$ to allow the drivers to turn off and data to be placed on the bus.
3. During this period, I/O pins are in the output state, and input signals must not be applied.
4. If the CE# low transition and CE2 high transition occurs simultaneously with or after WE# low transition, the outputs remain in a high impedance state.
5. t_{OW} and t_{WHZ} are specified with $C_L = 5\text{pF}$. Transition is measured $\pm 500\text{mV}$ from steady state.

DATA RETENTION CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
V _{CC} for Data Retention	V _{DR}	CE# ≥ V _{CC} - 0.2V or CE2 ≤ 0.2V	2.0	-	3.6	V	
Data Retention Current	I _{DR}	V _{CC} = 2.0V CE# ≥ V _{CC} - 0.2V or CE2 ≤ 0.2V	Normal	-	0.006	2	mA
		V _{CC} = 2.0V CE# ≥ V _{CC} - 0.2V or CE2 ≤ 0.2V Others at 0.2V or V _{CC} -0.2V	LL	-	0.5	30	μA
Chip Disable to Data Retention Time	t _{CDR}	See Data Retention Waveforms (below)	0	-	-	ns	
Recovery Time	t _R		t _{RC} *	-	-	ns	

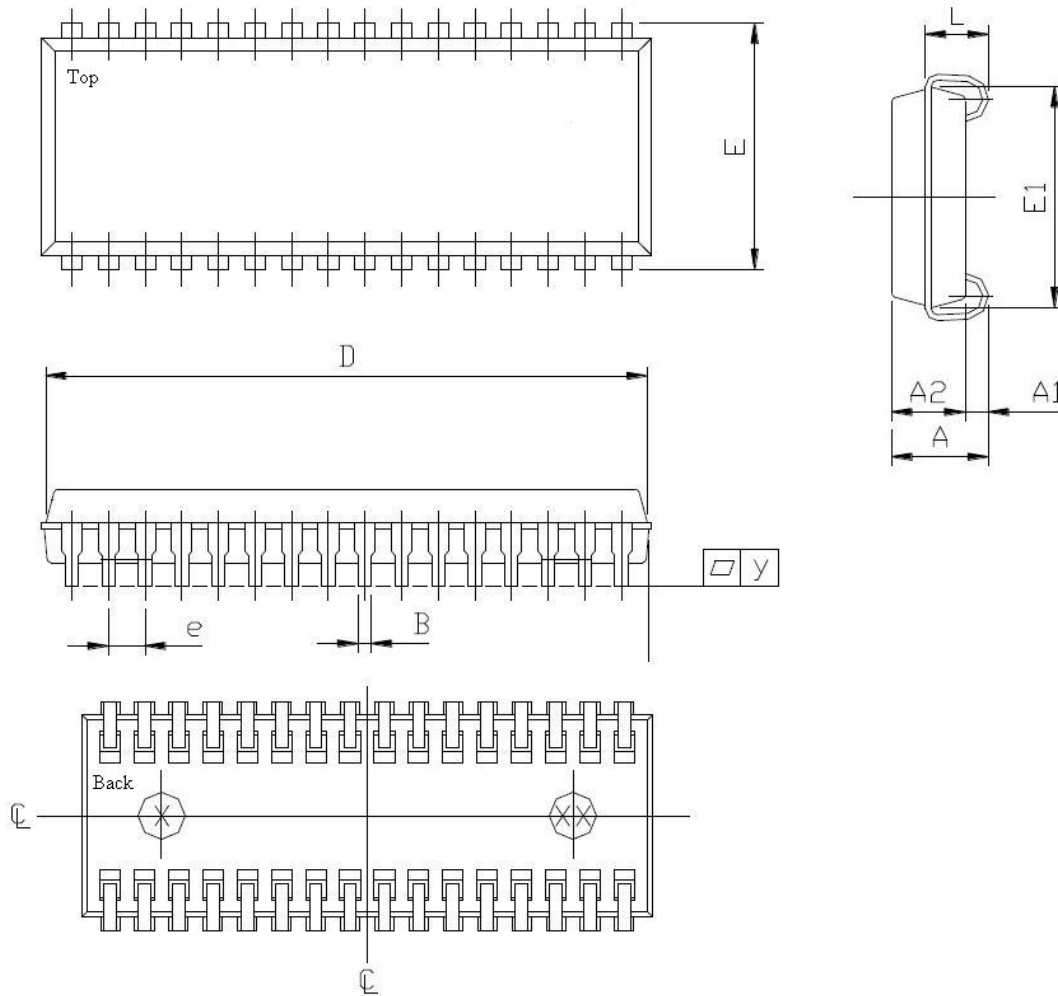
 t_{RC}* = Read Cycle Time

DATA RETENTION WAVEFORM
Low V_{CC} Data Retention Waveform (1) (CE# controlled)

Low V_{CC} Data Retention Waveform (2) (CE2 controlled)


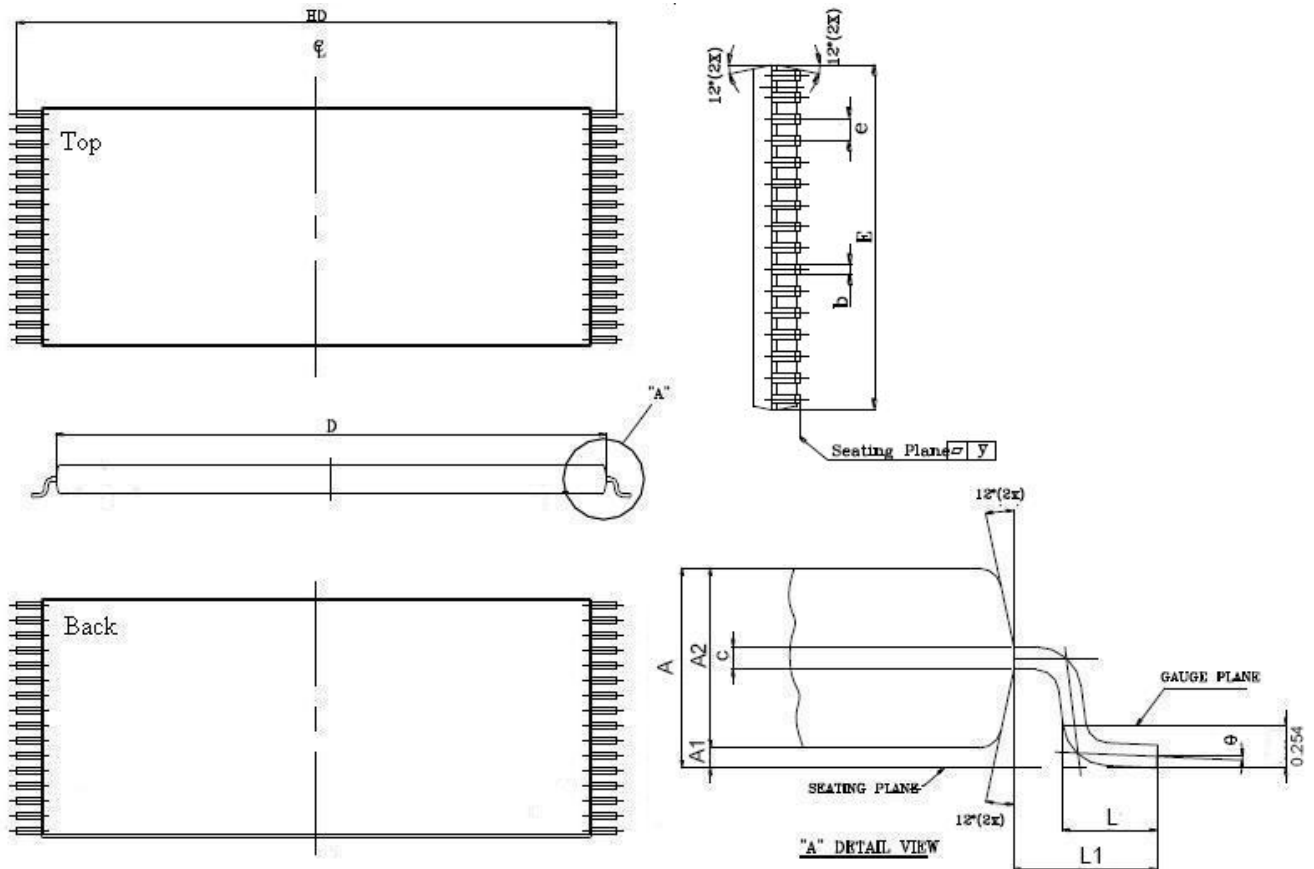


PACKAGE OUTLINE DIMENSION

32-pin 300mil SOJ Package Outline Dimension



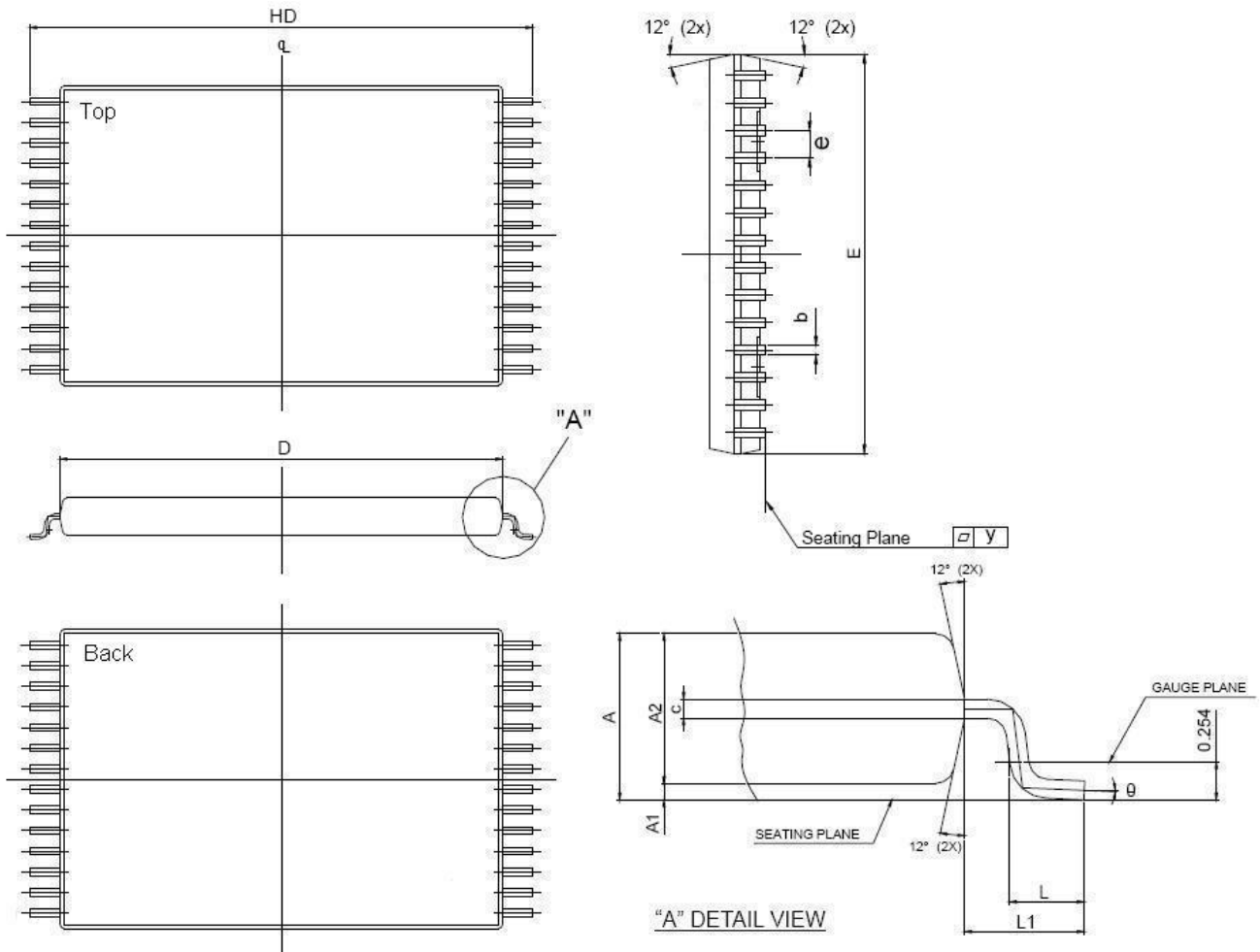
SYMBOL	UNIT	INCH(BASE)	MM(REF)
A		0.148(MAX)	3.759(MAX)
A1		0.025(MIN)	0.635(MIN)
A2		0.123(MAX)	3.124(MAX)
B		0.018(TYP)	0.457(TYP)
D		0.825±0.005	20.955±0.127
E		0.335(TYP)	8.509(TYP)
E1		0.300±0.005	7.620±0.127
e		0.050(TYP)	1.270(TYP)
L		0.086±0.010	2.184±0.254
y		0.003(MAX)	0.076(MAX)

32-pin 8mm x 20mm TSOP I Package Outline Dimension


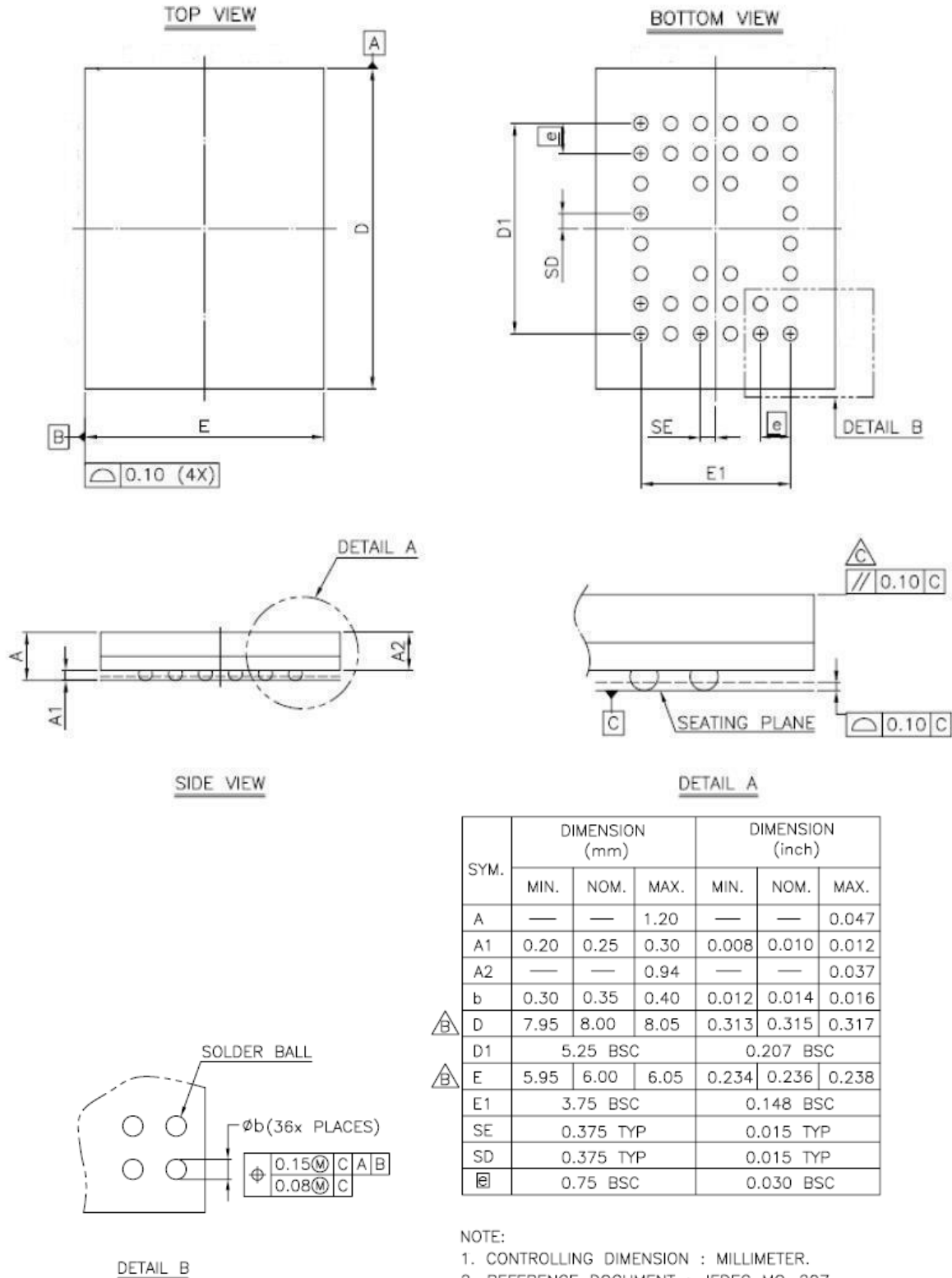
SYM.	UNIT	INCH(BASE)	MM(REF)
A		0.047 (MAX)	1.20 (MAX)
A1		0.004 ±0.002	0.10 ±0.05
A2		0.039 ±0.002	1.00 ±0.05
b		0.009 ±0.002	0.22 ±0.05
c		0.006 ±0.002	0.155 ±0.055
D		0.724 ±0.008	18.40 ±0.20
E		0.315 ±0.008	8.00 ±0.20
e		0.020 (TYP)	0.50 (TYP)
HD		0.787 ±0.008	20.00 ±0.20
L		0.024 ±0.004	0.60 ±0.10
L1		0.0315 ±0.004	0.08 ±0.10
y		0.003 (MAX)	0.08 (MAX)
∅		0°~5°	0°~5°



32-pin 8mm x 13.4mm sTSOP Package Outline Dimension



SYM.	UNIT	INCH(BASE)	MM(REF)
A		0.049 (MAX)	1.25 (MAX)
A1		0.004 ±0.002	0.10 ±0.05
A2		0.039 ±0.002	1.00 ±0.05
b		0.009 ±0.002	0.22 ±0.05
c		0.006 ±0.002	0.155 ±0.055
D		0.465 ±0.008	11.80 ±0.20
E		0.315 ±0.008	8.00 ±0.20
e		0.020 (TYP)	0.50 (TYP)
HD		0.528±0.008	13.40 ±0.20.
L		0.02 ±0.008	0.50 ±0.20
L1		0.031 ±0.005	0.8 ±0.125
y		0.003 (MAX)	0.076 (MAX)
θ		0°~5°	0°~5°

36-ball 6mm x 8mm TFBGA Package Outline Dimension

NOTE:

1. CONTROLLING DIMENSION : MILLIMETER.
2. REFERENCE DOCUMENT : JEDEC MO-207.



ORDERING INFORMATION

Package Type	Access Time (Speed)(ns)	Power Type	Temperature Range(°C)	Packing Type	Lyontek Item No.
32-pin (300mil) SOJ	10	Normal Power	0°C~70°C	Tube	LY61L1024JL-10
				Tape Reel	LY61L1024JL-10T
			-40°C~85°C	Tube	LY61L1024JL-10I
				Tape Reel	LY61L1024JL-10IT
	12	Normal Power	0°C~70°C	Tube	LY61L1024JL-12
				Tape Reel	LY61L1024JL-12T
			-40°C~85°C	Tube	LY61L1024JL-12I
				Tape Reel	LY61L1024JL-12IT
	18	Ultra Low Power	0°C~70°C	Tube	LY61L1024JL-18LL
				Tape Reel	LY61L1024JL-18LLT
			-40°C~85°C	Tube	LY61L1024JL-18LLI
				Tape Reel	LY61L1024JL-18LLIT



ORDERING INFORMATION

Package Type	Access Time (Speed)(ns)	Power Type	Temperature Range(°C)	Packing Type	Lyontek Item No.
32-pin (8mm x 20mm) TSOP I	10	Normal Power	0°C~70°C	Tray	LY61L1024LL-10
				Tape Reel	LY61L1024LL-10T
			-40°C~85°C	Tray	LY61L1024LL-10I
				Tape Reel	LY61L1024LL-10IT
	12	Normal Power	0°C~70°C	Tray	LY61L1024LL-12
				Tape Reel	LY61L1024LL-12T
			-40°C~85°C	Tray	LY61L1024LL-12I
				Tape Reel	LY61L1024LL-12IT
	18	Ultra Low Power	0°C~70°C	Tray	LY61L1024LL-18LL
				Tape Reel	LY61L1024LL-18LLT
			-40°C~85°C	Tray	LY61L1024LL-18LLI
				Tape Reel	LY61L1024LL-18LLIT

ORDERING INFORMATION

Package Type	Access Time (Speed)(ns)	Power Type	Temperature Range(°C)	Packing Type	Lyontek Item No.
32-pin (8mm x 13.4mm) sTSOP	10	Normal Power	0°C~70°C	Tray	LY61L1024RL-10
				Tape Reel	LY61L1024RL-10T
			-40°C~85°C	Tray	LY61L1024RL-10I
				Tape Reel	LY61L1024RL-10IT
	12	Normal Power	0°C~70°C	Tray	LY61L1024RL-12
				Tape Reel	LY61L1024RL-12T
			-40°C~85°C	Tray	LY61L1024RL-12I
				Tape Reel	LY61L1024RL-12IT
	18	Ultra Low Power	0°C~70°C	Tray	LY61L1024RL-18LL
				Tape Reel	LY61L1024RL-18LLT
			-40°C~85°C	Tray	LY61L1024RL-18LLI
				Tape Reel	LY61L1024RL-18LLIT



ORDERING INFORMATION

Package Type	Access Time (Speed)(ns)	Power Type	Temperature Range(°C)	Packing Type	Lyontek Item No.
36-ball (6mm x 8mm) TFBGA	10	Normal Power	0°C~70°C	Tray	LY61L1024GL-10
				Tape Reel	LY61L1024GL-10T
			-40°C~85°C	Tray	LY61L1024GL-10I
				Tape Reel	LY61L1024GL-10IT
	12	Normal Power	0°C~70°C	Tray	LY61L1024GL-12
				Tape Reel	LY61L1024GL-12T
			-40°C~85°C	Tray	LY61L1024GL-12I
				Tape Reel	LY61L1024GL-12IT
	18	Ultra Low Power	0°C~70°C	Tray	LY61L1024GL-18LL
				Tape Reel	LY61L1024GL-18LLT
			-40°C~85°C	Tray	LY61L1024GL-18LLI
				Tape Reel	LY61L1024GL-18LLIT



Lyontek Inc.

LY61L1024

Rev. 2.8

128K X 8 BIT HIGH SPEED CMOS SRAM

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